

Typical Applications Circuit







Pin Descriptions

Pin Number	Pin Name	Description
1	V _{IN}	Operating voltage input
2	Output	Switching output
3	Gnd	Ground
4	FB	Output voltage feedback control
5	SD	ON/OFF shutdown

Functional Block Diagram





AP1501A





Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
ESD MM	Machine Model ESD Protection	400	V
Vcc	Supply Voltage	+45	V
V _{SD}	SD Pin Input Voltage	-0.3 to +40	V
V _{FB}	FB Pin Voltage	-0.3 to +40	V
Vout	Output Voltage to Ground	-1	V
PD	Power Dissipation	Internally limited	W
T _{ST}	Storage Temperature	-65 to +150	°C
TJ	Operating Junction Temperature	-20 to +125	°C

Recommended Operating Conditions

Symbol	Parameter		Rating	Unit
Vop	Operating Voltage		4.5 to 40	V
TA	Operating Ambient Temperature		-20 to +85	°C



Electrical Characteristics (All Output Voltage Versions)

Unless otherwise specified, V_{IN} = 12V for 3.3V, 5V, adjustable version and V_{IN} = 24V for the 12V version. I_{LOAD} = 0.5A. Specifications with **boldface type** are for full operating temperature range, the other type are for T_J = +25°C.

Symbol	Parameter		Conditions	Min	Тур.	Мах	Unit
I _{FB}			V _{FB} = 1.3V (Adjustable version only)	_	40	60 100	nA
fosc	Oscillator Freque	ncy	_	127 110	150	173 173	kHz
VSAT	Saturation Voltage	e	I _{OUT} = 5A No outside circuit V _{FB} = 0V force driver on	_	1.5	1.6 1.7	V
DC	Max. Duty Cycle ((ON)	V _{FB} = 0V force driver on	—	100)_	%
DC	Min. Duty Cycle (OFF)	V _{FB} = 12V force driver off	—	0	—	70
ICL	Current Limit		Peak current No outside circuit V _{FB} = 0 force driver on	5.5	6.0	6.5 7.5	А
ار	Output = 0V	Output Leakage Current	No outside circuit V _{FB} = 12V force driver off (Note 4)		/-	200	μA
	Output = -1V	Current	V _{IN} = 40V		2	60	mA
lq	Quiescent Curren	t	V _{FB} = 12V force driver off	—	5	10	mA
I _{STBY}	Standby Quiescent Current		SD pin = 5V V _{IN} = 40V	-	150	250 300	μA
VIL			Low (regulator ON)			0.6	
V _{IH}	SD Pin Logic Input Threshold Voltage		High (regulator OFF)	2.0	1.3	_	V
Ін	SD Pin Logic Input Current		V _{LOGIC} = 2.5V (OFF)	-/	15	25	μA
ار	SD Pin Input Current		$V_{LOGIC} = 0.5V$ (ON)	Y	0.02	5	•
θιο			TO263-5 (Note 5)	—	37	—	°C/W
JA			TO220-5(R) (Note 5)	_	31	—	0,11
$\theta_{\rm JC}$	Thermal Resistance Junction-to-Case		TO263-5 (Note 5) TO220-5(R) (Note 5)		6 5		°C/W

4. FB pin removed from output and connected to 0V to force the output transistor switch ON. FB pin removed from output and connected to 12V for the Notes: 3.3V, 5V, and the ADJ, version, and 15V for the 12V version, to force the output transistor switch OFF. 5. Test condition: Device mounted with copper area of approximately 3inch², 1oz, no air flow.



Electrical Characteristics (continued)

Specifications with **boldface type** are for full operating temperature range, the other type are for $T_J = +25^{\circ}C$.

	Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
AP1501A-ADJ	V_{FB}	Output Feedback	$5V \le V_{IN} \le 40V$ $0.2A \le I_{LOAD} \le 5A$ V_{OUT} programmed for 3V	1.193/ 1.18	1.23	1.267/ 1.28	V
	η	Efficiency	V _{IN} = 12V, I _{LOAD} =5A	—	72	—	%
AP1501A-3.3V	V _{OUT}	Output Voltage	5.5V <u>≤</u> V _{IN} <u>≤</u> 40V 0.2A <u>≤</u> I _{LOAD} <u>≤</u> 5A	3.168/ 3.135	3.3	3.432/ 3.465	V
	η	Efficiency	V _{IN} = 12V, I _{LOAD} = 5A	_	71	_	%
AP1501A-5V	V _{OUT}	Output Voltage	8V <u>≤</u> V _{IN} <u>≤</u> 40V 0.2A <u>≤</u> I _{LOAD} <u>≤</u> 5A	4.8/ 4.75	5	5.2/ 5.25	V
	η	Efficiency	V _{IN} = 12V, I _{LOAD} = 5A	_	78	_	%
AP1501A-12V	V _{OUT}	Output Voltage	15V <u>≤</u> V _{IN} <u>≤</u> 40V 0.2A <u>≤</u> I _{LOAD} <u>≤</u> 5A	11.52/ 11.4	12	12.48/ 12.6	V
	η	Efficiency	V _{IN} = 16V, I _{LOAD} = 5A	_	88	_	%



Typical Performance Characteristics





Typical Performance Characteristics (continued)





AP1501A

Functional Description

Pin Functions

+V_{IN}

This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be present at this pin to minimize voltage transients and to supply the switching currents needed by the regulator.

Ground

Circuit ground.

Output

Internal switch. The voltage at this pin switches between $(+V_{IN} - V_{SAT})$ and approximately -0.5V, with a duty cycle of approximately V_{OUT} / V_{IN} . To minimize coupling to sensitive circuitry, the PC board copper area connected to this pin should be kept a minimum.

Feedback

Senses the regulated output voltage to complete the feedback loop.

ON/OFF

Allows the switching regulator circuit to be shutdown using logic level signals thus dropping the total input supply current to approximately 150µA. Pulling this pin below a threshold voltage of approximately 1.3V turns the regulator on, and pulling this pin above 1.3V (up to a maximum of 40V) shuts the regulator down. If this shutdown feature is not needed, the SD pin can be wired to the ground pin or it can be left open, in either case the regulator will be in the ON condition.

Thermal Considerations

The AP1501A is available in two packages, a 5-pin surface mount TO263-5, TO220-5 and TO220-5 (R).

The TO220-5 and TO220-5 (R) packages need a heat sink under most conditions. The size of the heat sink depends on the input voltage, the output voltage, the load current and the ambient temperature. The AP1501A junction temperature rises above ambient temperature for a 5A load and different input and output voltages. The data for these curves was taken with the AP1501A (TO220-5 and TO220-5 (R) packages) operating as a buck switching regulator in an ambient temperature of +25°C (still air). These temperature rise numbers are all approximate and there are many factors that can affect these temperatures. Higher ambient temperatures require more heat sinking.

The TO263-5 surface mount package tab is designed to be soldered to the copper on a printed circuit board. The copper and the board are the heat sink for this package and the other heat producing components, such as the catch diode and inductor. The PC board copper area that the package is soldered to should be at least 0.8 inch², and ideally should have 2 or more square inches of 2 oz. Additional copper area improves the thermal characteristics, but with copper areas greater than approximately 6 inch², only small improvements in heat dissipation are realized. If further thermal improvements are needed, double sided, multilayer PC boards with large copper areas and/or airflow are recommended.

The AP1501A (TO263-5 package) junction temperature rise above ambient temperature with a 2A load for various input and output voltages. This data was taken with the circuit operating as a buck switching regulator with all components mounted on a PC board to simulate the junction temperature under actual operating conditions. This curve can be used for a quick check for the approximate junction temperature for various conditions, but be aware that there are many factors that can affect the junction temperature. When load currents higher than 3A are used, double sided or multilayer PC boards with large copper areas and/or airflow might be needed, especially for high ambient temperatures and high output voltages.

For the best thermal performance, wide copper traces and generous amounts of printed circuit board copper should be used in the board layout. (Once exception to this is the Output pin, which should not have large areas of copper.) Large areas of copper provide the best transfer of heat (lower thermal resistance) to the surrounding air, and moving air lowers the thermal resistance even further.

Package thermal resistance and junction temperature rise numbers are all approximate, and there are many factors that will affect these numbers. Some of these factors include board size, shape, thickness, position, location, and even board temperature. Other factors are, trace width, total printed circuit copper area, copper thickness, single or double-sided, multilayer board and the amount of solder on the board. The effectiveness of the PC board to dissipate heat also depends on the size, quantity and spacing of other components on the board, as well as whether the surrounding air is still or moving.

Furthermore, some of these components such as the catch diode will add heat to the PC board and the heat can vary as the input voltage changes. For the inductor, depending on the physical size, type of core material and the DC resistance, it could either act as a heat sink taking heat away from the board, or it could add heat to the board.



		ļ	AP1501A <u>X</u>	<u>x xxx x</u> - <u>x</u>	x T				
Output Version		Pack	age	Green			Packing		
Blank : Adjustable 33 : 3.3V 50 : 5.0V 12 : 12V	K5 : TO263-5 T5 : TO220-5 T5R : TO220-5 (R)			G : Green			U : Tube 13 : Tape & Reel		
Device	Voltage	Package code	Package (Note 6)	Lead Free/ Green	Quantity		Number Suffix 13"Tape and reel	Status	
AP1501A-33K5G-13	33	K5	TO263-5	Green	800	NA	-13	End of Life	
AP1501A-12K5G-13	12	K5	TO263-5	Green	800	NA	-13	NRND	
AP1501A-50K5G-13	50	K5	TO263-5	Green	800	NA	-13	NRND	
AP1501A-K5G-13	ADJ	K5	TO263-5	Green	800	NA	-13	NRND	
AP1501A-12T5RG-U	12	T5R	TO220-5 (R)	Green	50	-U	NA	End of Life	
AP1501A-33T5RG-U	33	T5R	TO220-5 (R)	Green	50	-U	NA	End of Life	
AP1501A-50T5RG-U	50	T5R	TO220-5 (R)	Green	50	-U	NA	End of Life	
AP1501A-T5RG-U	ADJ	T5R	TO220-5 (R)	Green	50	-U	NA	End of Life	
AP1501A-12T5G-U	12	T5	TO220-5	Green	50	-U	NA	End of Life	
AP1501A-33T5G-U	33	T5	TO220-5	Green	50	-U	NA	End of Life	
AP1501A-50T5G-U	50	T5 🚺	TO220-5	Green	50	-U	NA	End of Life	
AP1501A-T5G-U	ADJ	Т5	TO220-5	Green	50	-U	NA	End of Life	
AP1501A-12K5G-U	12	K5	TO263-5	Green	50	-U	NA	End of Life	
AP1501A-33K5G-U	33	K5	TO263-5	Green	50	-U	NA	End of Life	
AP1501A-50K5G-U	50	К5	TO263-5	Green	50	-U	NA	End of Life	
AP1501A-K5G-U	ADJ	K5	TO263-5	Green	50	-U	NA	End of Life	

Notes:

6. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.





Marking Information (Note 6)





Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: TO263-5





Package Outline Dimensions (continued)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) Package Type: TO220-5 (R)



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: TO263-5



Dimensions	Value (in mm)
Х	10.9
X1	1.05
Y	15.7
Y1	9.1
Y2	2.5
С	1.7



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